| ASSOCIATION CONNECTING<br>ASSOCIATION CONNECTING<br>ELECTRONICS INDUSTRIES®<br>international and Pa | IPC. Bannockb   | ourn. Illinois. A              | All rights reserved un ntions. | nder both               | This docume<br>level parts, t  | ent is a declaration en | n of the subst<br>compasses all | ances within the manuf<br>lower level materials f | acturer liste<br>or which the   | d item. Note: if<br>e manufacturer | the item is an as<br>has engineering | ssembly with low responsibility. |  |
|---|---|--------------------------------|--------------------------------|-------------------------|--|-------------------------|---------------------------------|---|---------------------------------|------------------------------------|--------------------------------------|----------------------------------|--|
|   |   |                                |                                | Form Type<br>Distribute | e * Declaration Class *<br>Class 6 - RoHS Yes/No, Homogeneous Material |                         |                                 |   | aterials and                    | uls and Mfg Information            |                                      |                                  |  |
| Supplier Information  |   |                                |                                |                         |  |                         |                                 |   |                                 |                                    |                                      |                                  |  |
| Company name* Company t   |   |                                | y unique ID                    |                         |  | Unique ID Authority     |                                 |   |                                 | Response Date*                     |                                      |                                  |  |
| onsemi  |   |                                |                                |                         |  |                         |                                 |   | 2023-06-08                      |                                    |                                      |                                  |  |
| ontact Name Title - Contact   |   |                                |                                |                         | Phone - Contact*   |                         |                                 |   | Email - Contact*                |                                    |                                      |                                  |  |
| Product-Env-Stewards Product Enviro Con   |   |                                | o Compliance                   |                         | NA   |                         |                                 | Prod  | Product-Env-Stewards@onsemi.com |                                    |                                      |                                  |  |
| Authorized Representative* Title - Representative   |   |                                | sentative                      | ntative P               |  | Phone - Representative* |                                 |   | Emai                            | Email - Representative*            |                                      |                                  |  |
| Product-Env-Stewards Product E  |   |                                | duct Enviro Compliance         |                         |  | NA                      |                                 |   | Prod                            | Product-Env-Stewards@onsemi.com    |                                      |                                  |  |
| Requester Item Number   | ber Mfr Item Number                                       |                                | mber Mfr Item Name             |                         |  | Effective Date          | Version                         | Manufacturing Sit                                 | Manufacturing Site              |                                    | UOM                                  | Unit Type                        |  |
|   | AMIS-49   | AMIS-49200-XTD AMIS-49200 FIEL |                                | LDBUS MAU               | Г  | 2023-06-08 PHG          |                                 |   | 332.6                           | mg                                 | Each                                 |                                  |  |
| Aanufacturing Proccess Informa  | ntion   |                                |                                |                         |  | ·                       |                                 |   |                                 |                                    |                                      | •                                |  |
| Terminal Plating / Grid Array M   | erminal Plating / Grid Array Material Terminal Base Alloy |                                | Alloy J-                       | STD-020 MSL             | Rating   | Peak Proce              | s Body Temp                     | erature Max Time at I                             | Peak Tempe                      | erature Numbe                      | er of Reflow Cy                      | cles                             |  |
| Matte Tin (Sn) - annealed CU Alloy 3  |   |                                |                                |                         | 260  | C                       | 30                              | sec   | conds 3                         |                                    |                                      |                                  |  |
| omments   |   |                                |                                |                         |  |                         |                                 |   |                                 |                                    |                                      |                                  |  |
| TTENTION: MSL 3 Rated item require  | es Bake and D   | ry Pack (after                 | r electrical test)             |                         |  |                         |                                 |   |                                 |                                    |                                      |                                  |  |
| or more information regarding material  | l composition   | please refer to                | o page 3                       |                         |  |                         |                                 |   |                                 |                                    |                                      |                                  |  |

| RoHS Material Composition Declaration  |   |  |   | Declaration Type *                              | Detailed  |  |  |  |  |  |
|--|---|--|---|---|---|--|--|--|--|--|
| Directive 2015/863/EU amending RoHS<br>Directive 2011/65/EU  | RoHS Definition: Quantity limit of 0.01% by mass (100 PPM) in homogeneous material for Cadmium and quantity limit of 0.1% by mass (1000 PPM) in homogeneous material for: Lead (Pb), Mercury (Hg), Hexavalent Chromium (Cr6+), Polybrominated Biphenyls (PBB), Polybrominated Diphenyl Ethers (PBDE), and Bis(2-ethylhexyl) phthalate (DEHP), Benzyl-butyl phthalate (BBP), Dibutyl phthalate (DBP), Diisobutyl phthalate (DIBP). |  |   |   |   |  |  |  |  |  |
| cadmium, hexavalentchromium, polybrominate<br>contains a RoHS restricted substance inexcess<br>encompass all such components. Supplier certif<br>as of the date that Supplier completes this form<br>Company acknowledges that Supplier may hav<br>independently verified information provided by<br>certification in this paragraph. If the Company a | ed biphenyls and/or polybrominated dip<br>of an applicable quantity limit, please ir<br>ies that it gathered the information it pro-<br>.Supplier acknowledges that Company<br>e relied on informationprovided by othe<br>y others, Supplier agrees that, at a minin<br>and the Supplier enter into a written agre<br>pource of the Supplier's liability and the  | henyl ethers (each a "<br>ndicate below which, i<br>ovides in this form us<br>will rely on this certifiers<br>in completing this<br>num, itssuppliers have<br>eement with respect to<br>Company's remedies | RoHS restricted substance") in exce<br>if any, RoHS exemption you believe<br>ing appropriate methods to ensure if<br>ication in determining the complian<br>form, and that Supplier may not have<br>e provided certifications regarding the<br>to the identified part, the terms and cc<br>for issues that arise regarding inform | ce of its products with European Union membe    | ove. If a homogeneous material within the part<br>er level components, the declaration shall<br>l correct to the best of its knowledge and belief,<br>r state laws that implement the RoHS Directive.<br>wever, in situations where Supplier has not<br>tions are at least as comprehensive as the<br>anty rights and/or remedies provided as part of |  |  |  |  |  |
| RoHS Declaration * 1 - Item(s)   | does not contain RoHS restricted substa   | ances per the definitio  | on above  | Supplier Acceptance                             | * Accepted  |  |  |  |  |  |
| Exemption: If the declared item does not con applicable exemptions.  | ntain RoHS restricted substances per  | the definition above   | except for defined RoHS exempti   | ons, then select the corresponding response i   | n the RoHS Declaration above and choose all   |  |  |  |  |  |
| Exemption List Version   | EL-2011/534/EU  |  |   |   |   |  |  |  |  |  |
| Declaration Signature  |   |  |   |   |   |  |  |  |  |  |
| Instructions: Complete all of the required fin<br>Requester) and click on Submit Form to have  | elds on all pages of this form. Select the form returned to the Requester   | he "Accepted" on th  | e Supplier Acceptance drop-down   | . This will display the signature area. Digital | lly sign the declaration (if required by the  |  |  |  |  |  |
| Supplier Digital Signature Ra  | stislav Drska   | Le   |   |   |   |  |  |  |  |  |

## Homogeneous Material Composition Declaration for Electronic Products

SubItem Instructions: The presence of any JIG Level A or B substances must be declared. [1] indicate the subpart in which the substance is located, [2] provide a description of the homogeneous material [3], enter the weight of the homogeneous material.

| sigma range of distribution unless otherwise noted). |        |                 |          |                              |                  |        |          |                 |  |
|--|--------|-----------------|----------|------------------------------|------------------|--------|----------|-----------------|--|
| Homogeneous Material                                 | Weight | Unit of Measure | Level    | Substance                    | CAS              | Exempt | Weight   | Unit of Measure |  |
| Die  | 36.42  | mg              | Supplier | Silicon (Si)                 | 7440-21-3        |        | 36.42    | mg              |  |
| Die Attach   | 6.07   | mg              | Supplier | Silver (Ag)                  | 7440-22-4        |        | 4.5525   | mg              |  |
|  |        |                 | Supplier | Epoxy resins                 | 129915-35-1      |        | 1.5175   | mg              |  |
| Lead Frame   | 108.86 | mg              | Supplier | Tin (Sn)                     | 7440-31-5        |        | 0.2722   | mg              |  |
|  |        |                 | Supplier | Zinc (Zn)                    | 7440-66-6        |        | 0.2177   | mg              |  |
|  |        |                 | Supplier | Chromium (Cr)                | 7440-47-3        |        | 0.3266   | mg              |  |
|  |        |                 | Supplier | Copper (Cu)                  | 7440-50-8        |        | 108.0435 | mg              |  |
| Mold Compound-Black                                  | 175.48 | mg              |          | Epoxy resin                  | proprietary data |        | 8.774    | mg              |  |
|  |        |                 | Supplier | Phenolic Resin               | Proprietary Data |        | 4.036    | mg              |  |
|  |        |                 | Supplier | Silica Amorphous (SiO2)      | 7631-86-9        |        | 8.774    | mg              |  |
|  |        |                 | Supplier | Carbon Black (C)             | 1333-86-4        |        | 0.7019   | mg              |  |
|  |        |                 | Supplier | Aluminum Hydroxide (Al(OH)3) | 21645-51-2       |        | 4.036    | mg              |  |
|  |        |                 | Supplier | Fused Silica (SiO2)          | 60676-86-0       |        | 149.158  | mg              |  |
| Plating  | 3.97   | mg              | Supplier | Tin (Sn)                     | 7440-31-5        |        | 3.97     | mg              |  |
| Wire Bond - Au                                       | 1.8    | mg              | Supplier | Gold (Au)                    | 7440-57-5        |        | 1.8      | mg              |  |

Substance Instructions: [A] select the Level (JIG A, JIG B, Requester or Supplier) [B] select the substance category (JIG or Requester) or enter a value (Supplier). [C] select the substance (JIG) or enter the substance and CAS (Other). [D] select a RoHS exemption, if applicable [E] enter the weight of the substance or the PPM concentration [F] Optionally enter the positive (+) and negative (-) tolerance in percent (Note: percent tolerance values are expected to cover a 3 signa range of distribution unless otherwise noted).